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98 P 4137 P

BOX AF

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By: 

Date: May 26, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 09/761,594 Confirmation No. 5815
Applicant : Hans-Jürgen Hacke et al.
Filed : January 16, 2001
TC/A.U. : 1733
Examiner : John T. Haran
Title: : Semiconductor Device in Chip Format and
Method for Producing It

Docket No. : GR 98 P 4137 P
Customer No. : 24131

BOX AF

Hon. Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE under 37 C.F.R. § 1.116

S i r :

In response to the final Office action dated March 10, 2004,
please consider the following remarks or arguments:

Remarks/Arguments begin on page 2 of this paper.